

APPLICATION DATA SHEET**Inventor Information**

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Application Information

Title : STRUCTURE AND METHOD FOR TRANSVERSE FIELD
ENHANCEMENT
Total Drawing Sheets : 13
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Application Type : Utility
Attorney Docket Number : 500990.03 (30013/US/2)
Assigned : Yes (Large Entity)

Representative Information

Representative Customer No. : 27,076

Continuity Information

This application is a	:	divisional of
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